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**SPRING COLLEGE IN MATERIALS SCIENCE
ON
'CERAMICS AND COMPOSITE MATERIALS'
(17 April - 26 May 1989)**

**CREEP AND DEFORMATION
(Overheads)**

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These are preliminary lecture notes, intended only for distribution to participants.

Outline of Lecture Series

Estimated
Schedule

O. Overview

- A. Fundamentals of Creep and Deformation
Deformation at low and high temperature
Experimental techniques
Experimental results and data presentation

L_1 + Dislocation
Plastic deformation
and
Strengthening

- B. Mechanisms of Creep Deformation
Diffusional Creep
Dislocation Based Creep
Class I Solid Solutions
Grain Boundary Sliding
Dispersion strengthened materials
The Big Picture -- Maps and the Dorn Equation

L_2

L_3

- C. Creep in Specific Systems
Comparison between metallic and ceramic creep
Superplasticity
basic principles
zirconia

L_4

- D. High Temperature Cavitation and Crack Growth
Types of Damage
Multiaxial Stress States
Crack Growth at elevated Temperature

- E. Effects of Internal Stresses - And Creep of Composites
Experimental Observations
Phase changes
Changing Temperature
Whisker reinforced composites
Fiber reinforced composites

L_5

- F. Creep Resistant Materials

Basic Modes of Deformation

1) Elastic

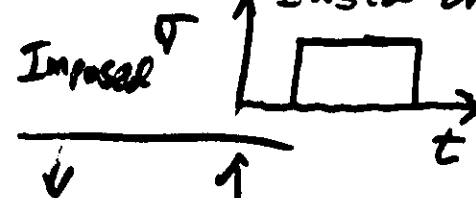
- Reversible
- Not time dependent
- Based on bond stretching

2) Anelastic

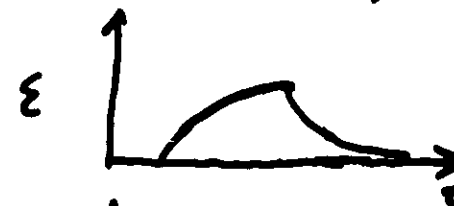
- Reversible
- time dependent
- Based on reversible disloc. Motion or G.B.

3) Plastic

- Irreversible
- Usually time dependent
- Based on Motion of dislocations or diffusional flow



Elastic



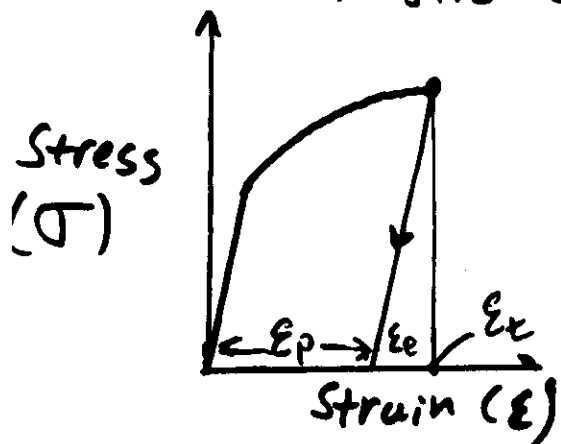
Anelastic



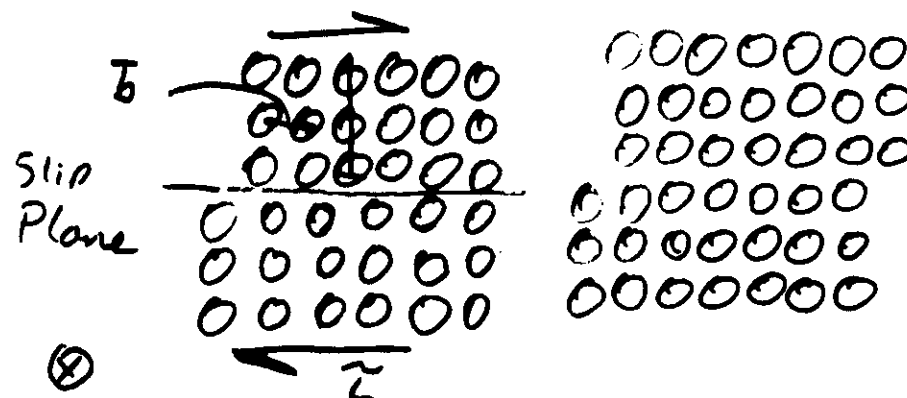
Plastic

Sometimes
hard to
distinguish

Another way to see Elastic & Plastic Deformation



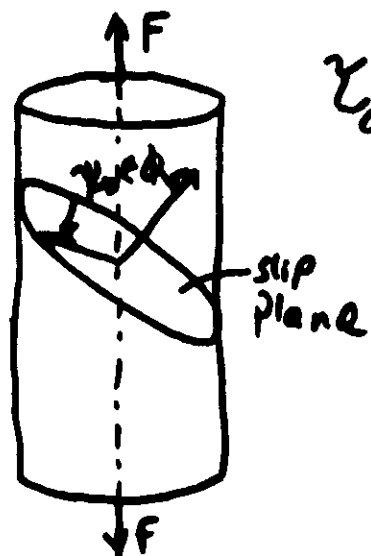
Plastic deformation is the result of Dislocation Motion



⊗
Line direction

Mechanism of Plastic Deformation

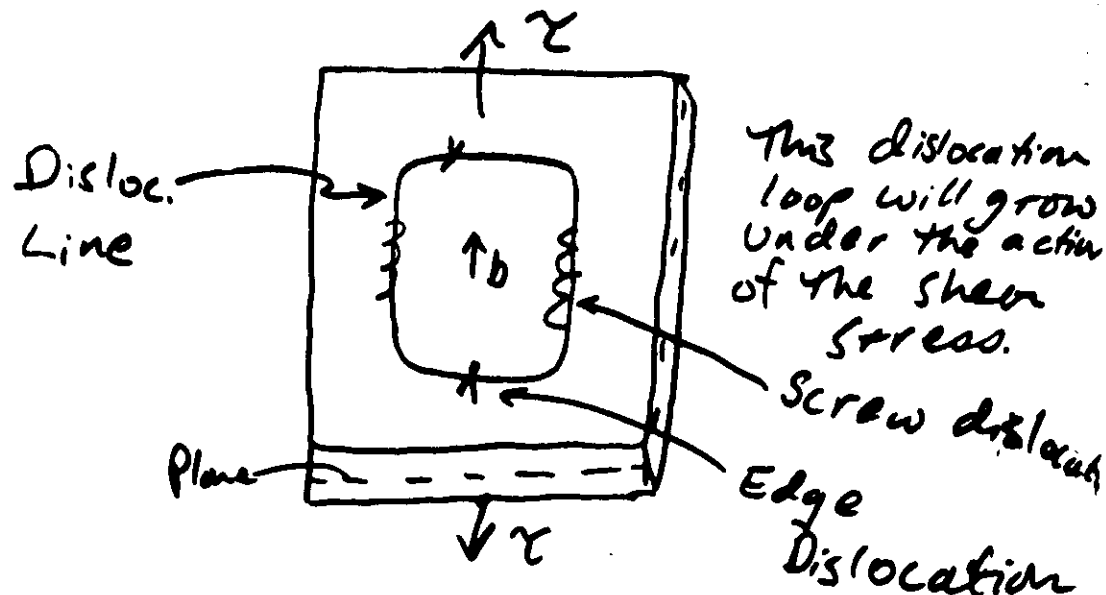
Single Crystals
Experimentally found that flow occurs on specific planes, in specific directions in response to a shear stress, τ



$$\tau_{crit} = \frac{F}{A} \cos \phi \cos \psi$$

• Note: Plastic deformation responds to shear stresses only!

Note that the dislocation line is the boundary between slipped and un-slipped regions.



Force on dislocation, $F = \tau \cdot b$

Stress fields associated w/ dislocations

$$\sigma \propto \frac{\mu b}{r}$$

μ = Shear Modulus
 b = Burgers Vector
 r = distance

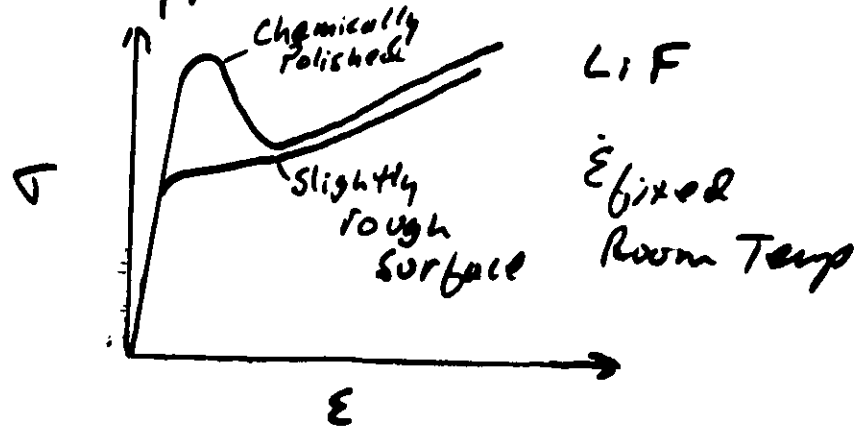
Also, There is a line tension

$$E \propto \mu b^2$$

Now we may use this to understand deformation.

1) Single Crystals

Typical Ceramic σ - ϵ curves



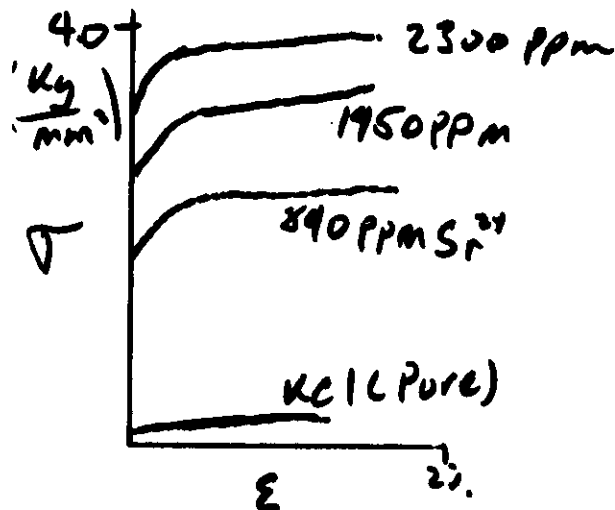
$$\frac{d\epsilon}{dt} = \dot{\epsilon} = \rho v b$$

if ρ very low high σ needed for flow.
 dislocations multiply and interact
 increasing ρ and σ with strain

Interactions with point defects

Consider addition of SrCl_2 to KCl

K vacancies form and produce dipoles w/ Sr ions

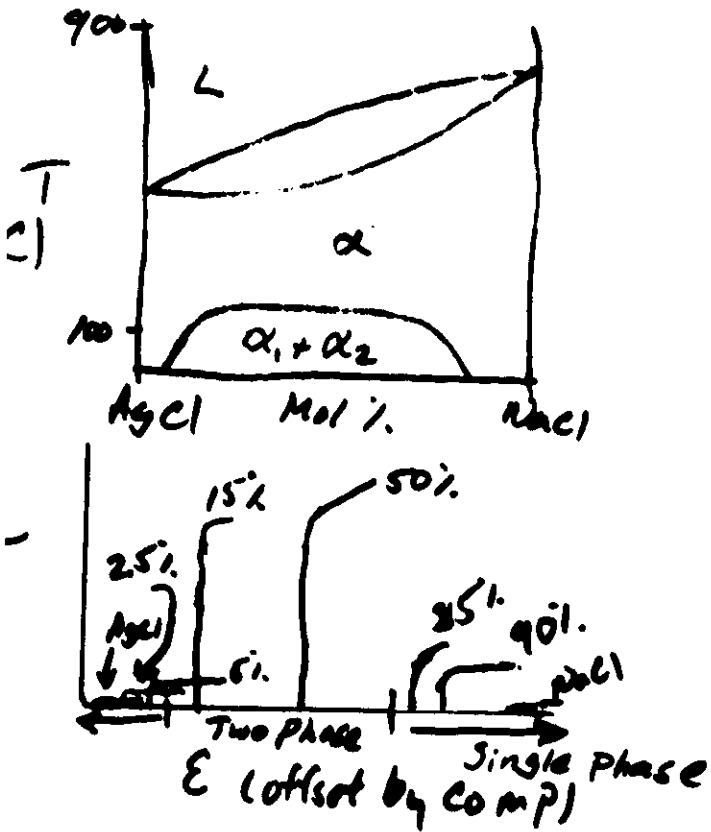


Two effects
 1) Strain field interaction

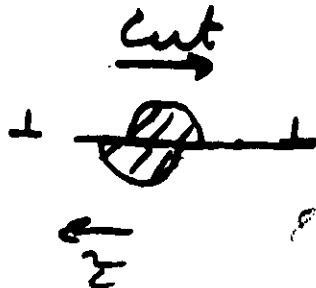
2) breaking of dipoles

Usually $\sigma_y \propto C^{\frac{1}{2}}$

Effect of Precipitates & solutes



For small dispersed precipitates, dislocations must cut or bow around the precipitates



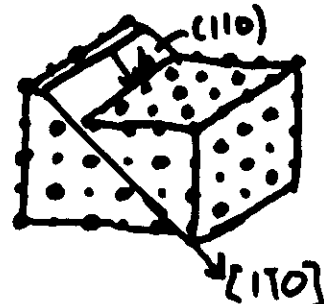
Deformation of Polycrystalline Solids

- 5 independent slip systems are required for general deformation by slip.
 - This condition is only found at elevated temperature by ceramic materials.

- It is difficult to propagate slip through grain boundaries. Thus at low T small grains strengthen a solid against slip deformation (Hall-Petch)

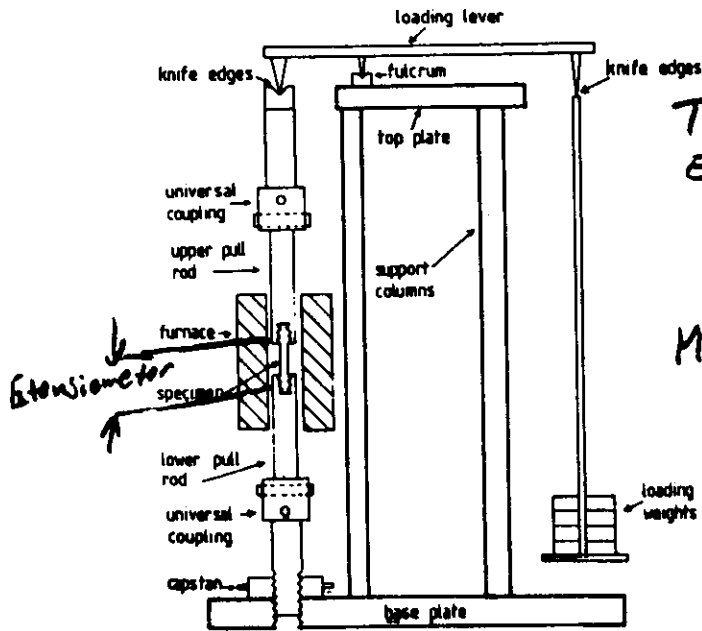
$$\sigma = \sigma_0 + k d^{-1/2}$$

Consider NaCl structure at low temp only {110} <110> system is available.



Note: Ions with same charge never become nearest neighbors.

Properties at Elevated Temperature



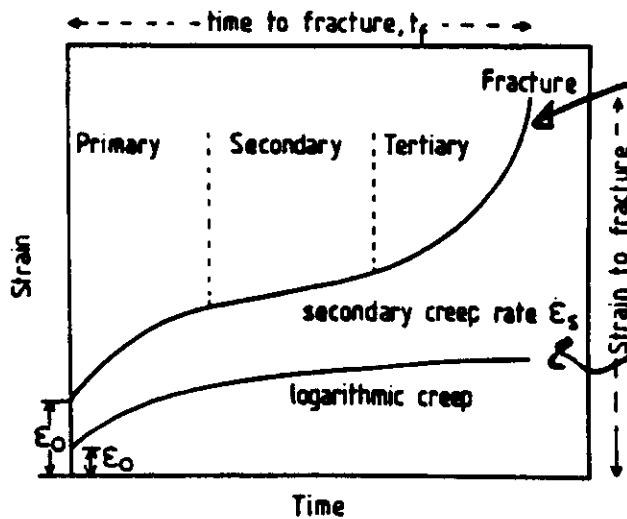
Typical Creep Experiment

Measure Δl with $z \rightarrow$

$$e = \frac{\Delta l}{l_0}$$

$$\epsilon = \ln(1 + e)$$

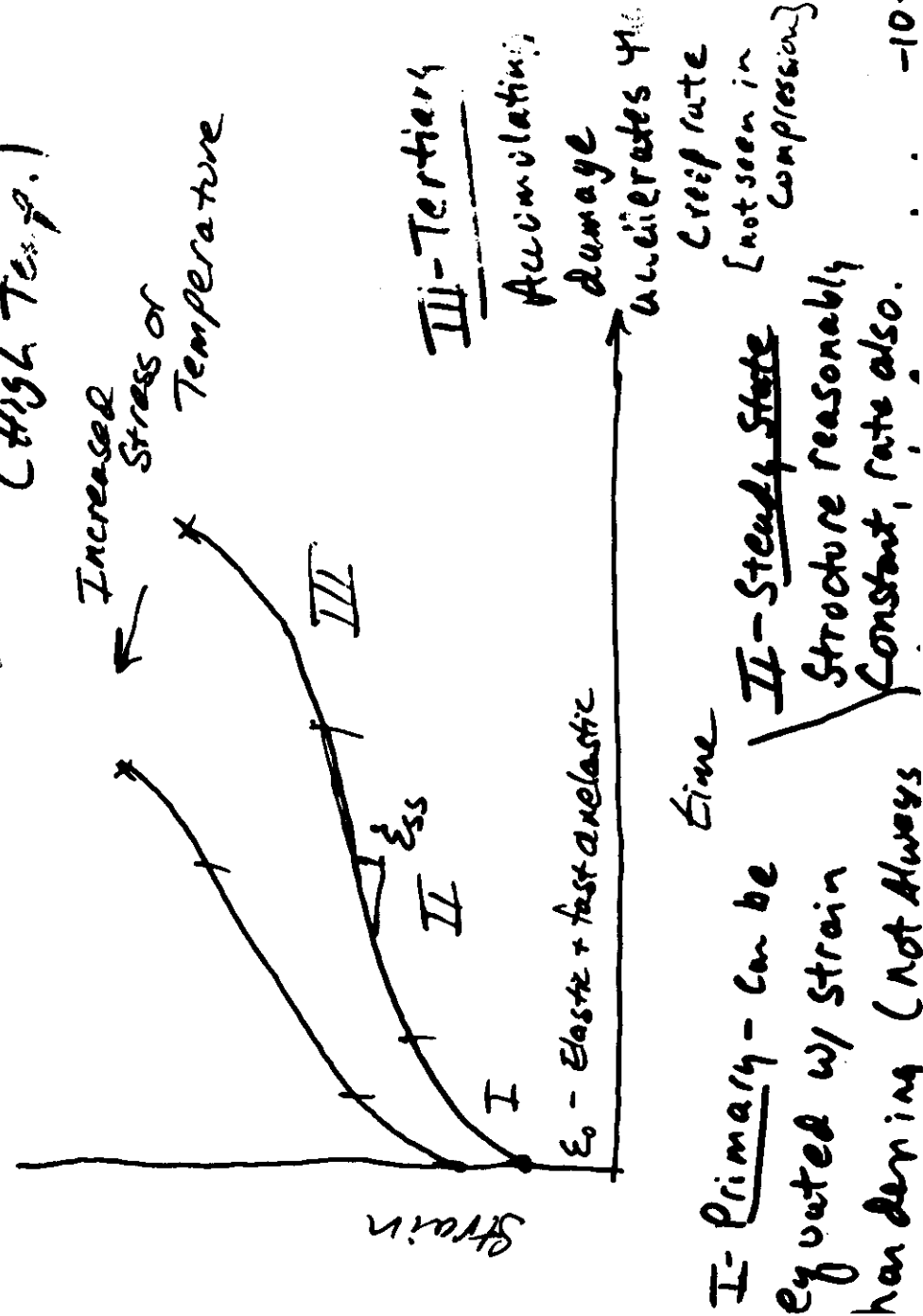
$$\sigma = F/A$$



Typical for elevated T

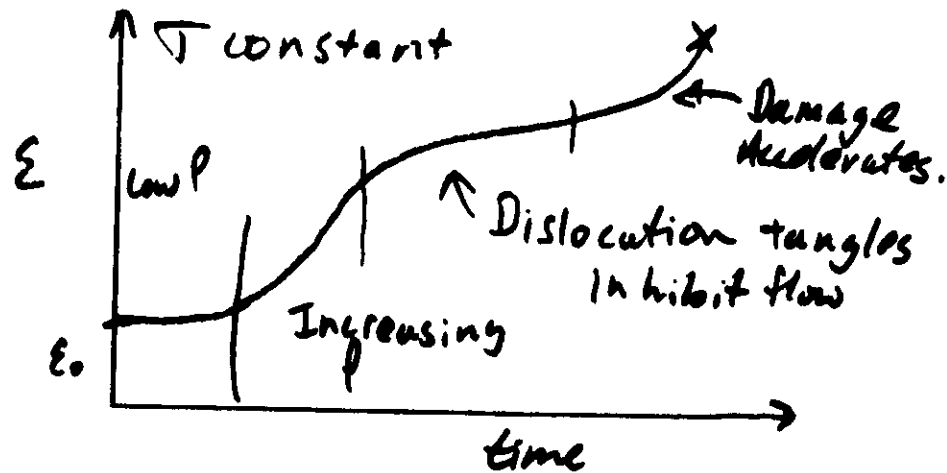
Typical at low T

Interpretation of Creep Curves (High Temp.)

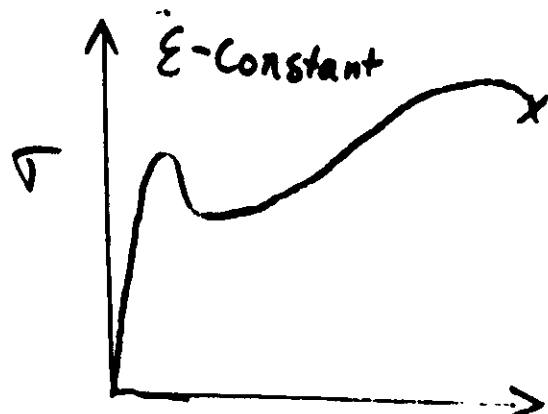


Creep Curves with other shapes can also be understood...

Single xtls w/ low P_0 :



Corresponding Stress Strain Curve

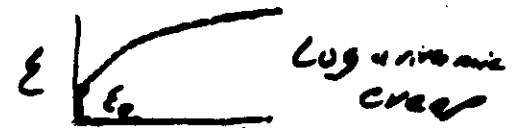


Complementary Information!

Deformation at Low & high Temp.

Low ($< 0.35 T_m$) — Note: seldom accessible w/ Polycrystalline Ceramics
Analyses of deformation based on Strain hardening alone work well.
Weak time-dependancy

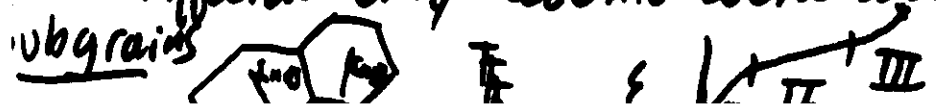
Cells:



Intermediate ($0.35 T_m$ to $0.6 T_m$)

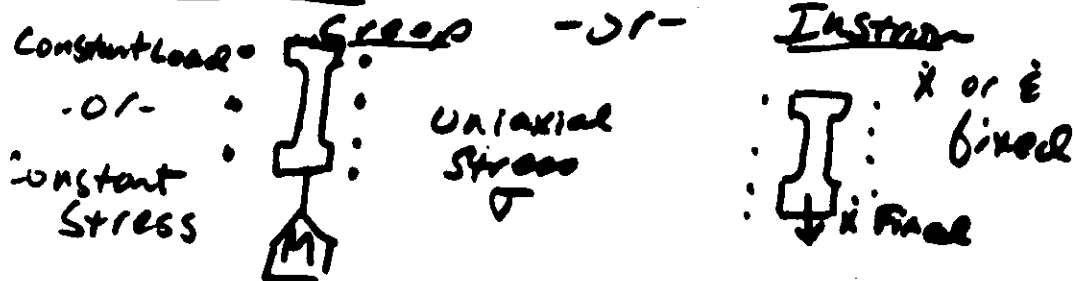
- Significant time dependancy
- Structure will change w/ strain
- Diffusion & hardening should be considered

high ($> 0.6 T_m$) • Large time dependancy
• Structure almost simple function of stress only
• Diffusion-only accounts work well only



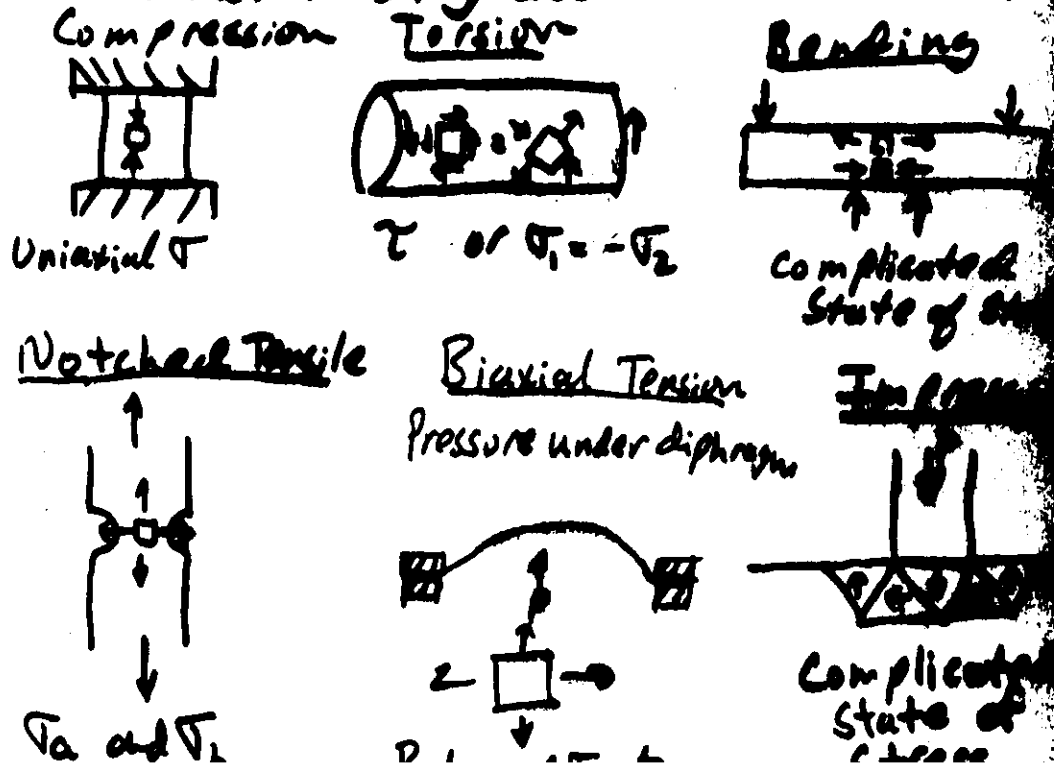
TEST Methods

Tensile



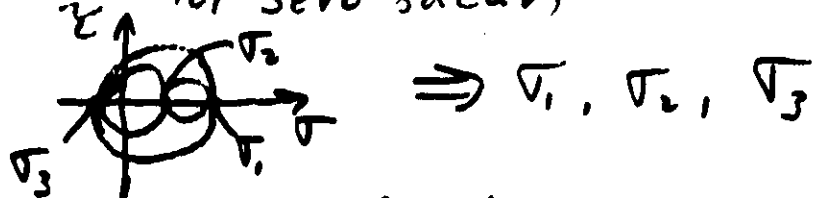
Comparable data is obtained either way.

Other loading geometries Available, to



Despite differences, data from all loading conditions can be correlated, assuming the material is isotropic

- 1) Find Principal Stresses (rotate axes for zero shear)



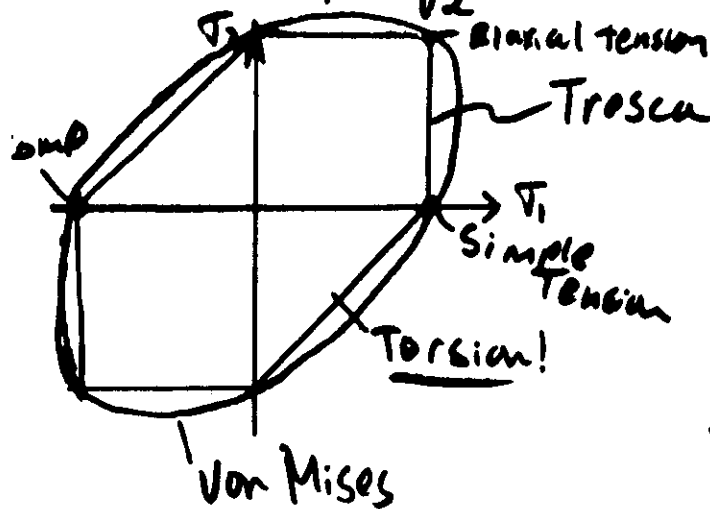
- 2) Need a flow law:

Tresca

$$\tau_{\max} = \tau_{\text{crit}} = \frac{\sigma_1 - \sigma_3}{2} \Rightarrow \text{Flow}$$

Von Mises

$$\sigma_y = \frac{1}{\sqrt{2}} ((\sigma_1 - \sigma_2)^2 + (\sigma_2 - \sigma_3)^2 + (\sigma_3 - \sigma_1)^2)^{1/2}$$



This is all OK for yielding but we need a different formulation for Creep. ... $\rightarrow$

Effective Stress and Strain

Based on previous criteria.

Effective Stress, $\bar{\sigma}$

Tresca $\bar{\sigma} = 2\sigma_{max} = \sigma_1 - \sigma_2$

Von Mises $\bar{\sigma} = \frac{1}{\sqrt{2}} ((\sigma_1 - \sigma_2)^2 + (\sigma_1 - \sigma_3)^2 + (\sigma_2 - \sigma_3)^2)^{\frac{1}{2}}$

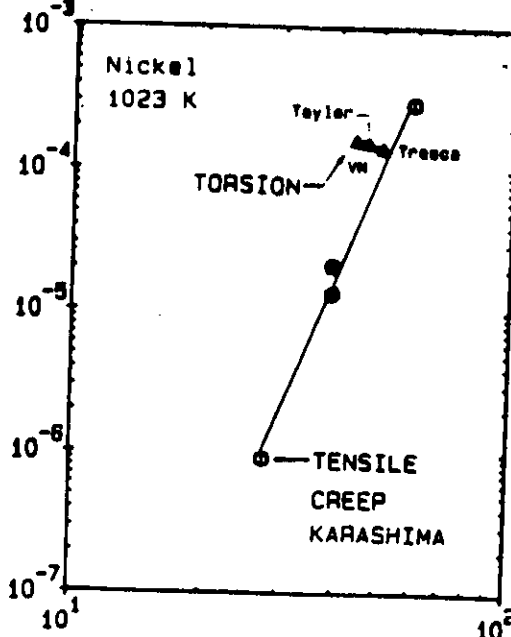
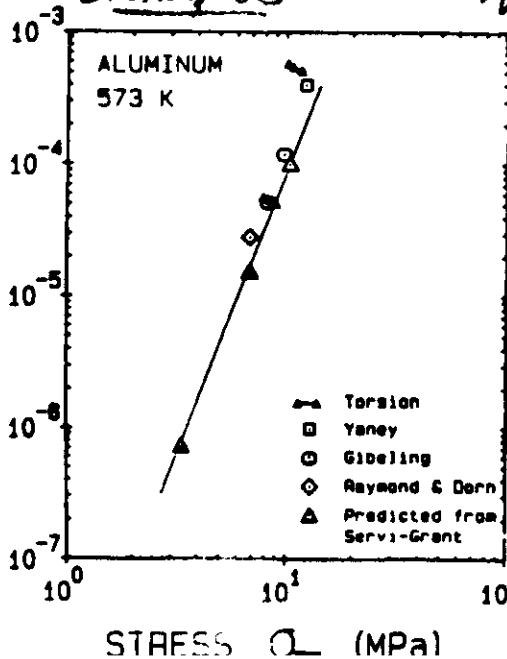
By work arguments, effective strain $\bar{\epsilon}$

Tresca $\bar{\epsilon} = \frac{\epsilon}{2}$

Von Mises $\bar{\epsilon} = \left[\frac{2}{3} (\epsilon_1^2 + \epsilon_2^2 + \epsilon_3^2) \right]^{\frac{1}{2}}$ (Proportional Strain Path)

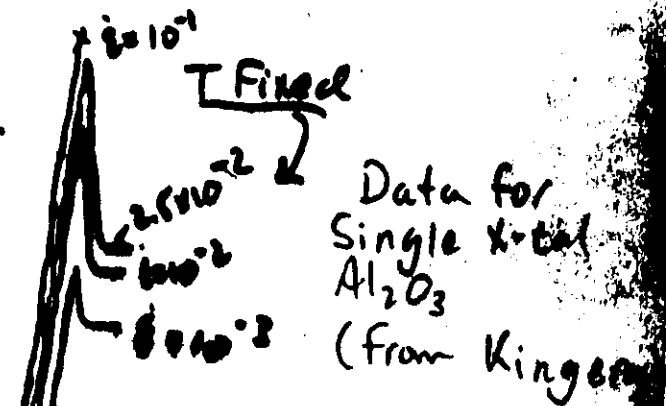
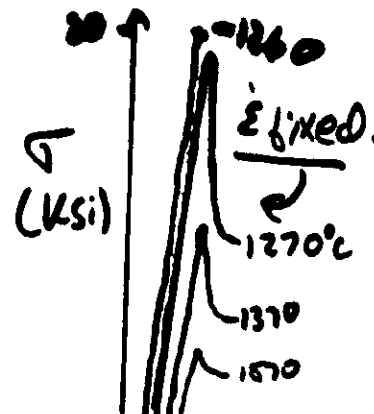
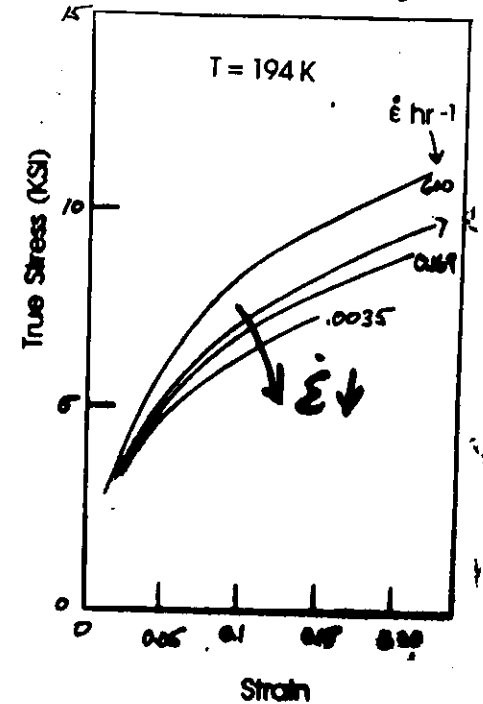
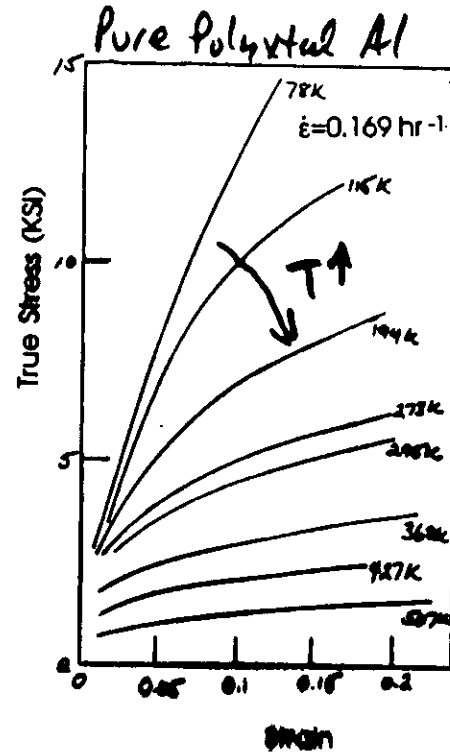
Note: This analysis applies to plastic def.
Only flow via void formation requires a different analysis.

Examples



Effects of Temperature & $\dot{\epsilon}$

$T \uparrow$ and $\dot{\epsilon} \downarrow$ can be traded... (essentially)



Data for Single Crystal Al_2O_3 (from King)

Analysis

- Plastic deformation is a thermally activated process!

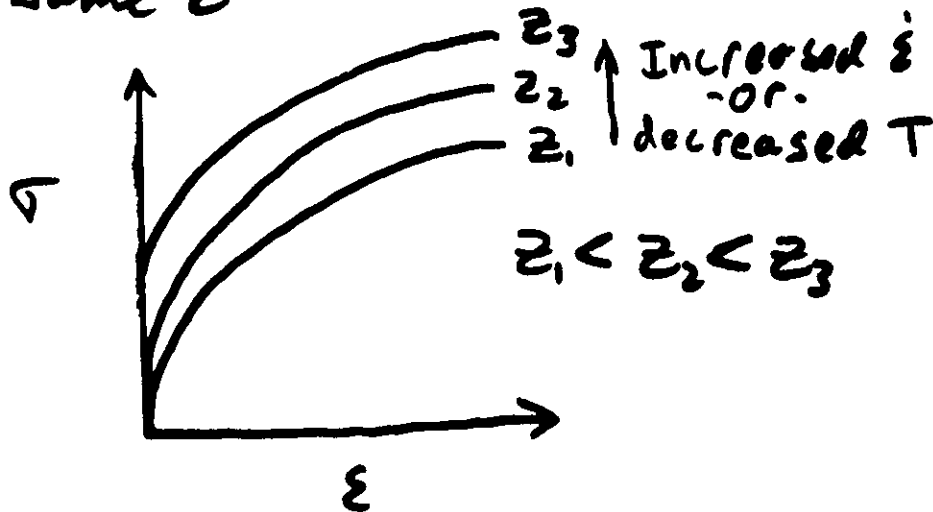
Zener-Holoman parameter, Z

$$\dot{\epsilon} = \Phi(\epsilon, Z)$$

$$Z = \dot{\epsilon} \exp\left(\frac{Q}{RT}\right)$$

activation E.
for plastic flow
(also called Q)

Thus σ - ϵ curves will fall atop each other if performed at the same Z

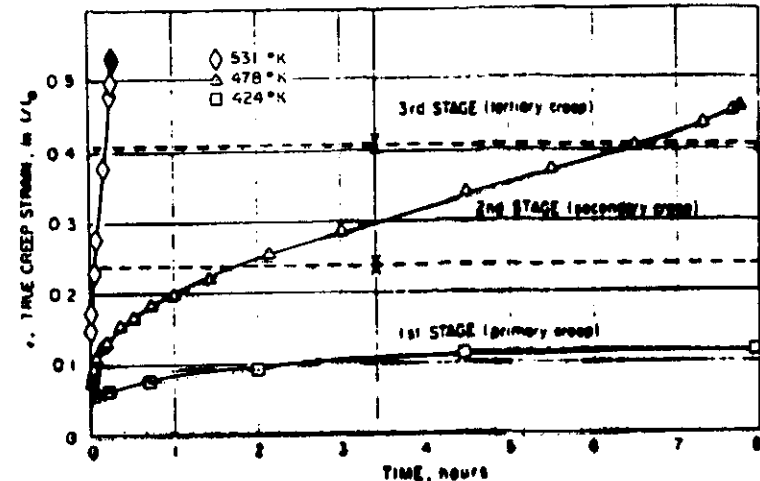


Reporting of yield stress is not meaningful

The Sherby-Orr-Dorn approach to Life Prediction.

Zener-Holoman in creep!

Pure Polycrystalline Al at 3,000 psi

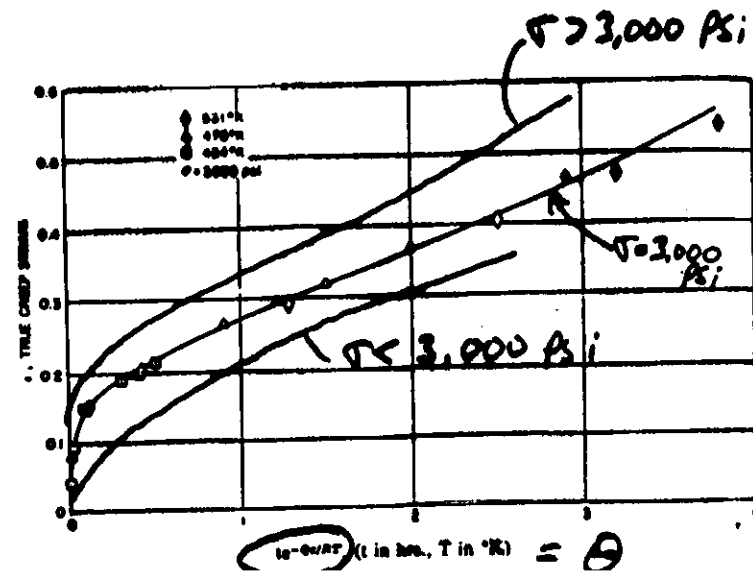


Here we say...

$$\epsilon = \Phi(\sigma, \Theta)$$

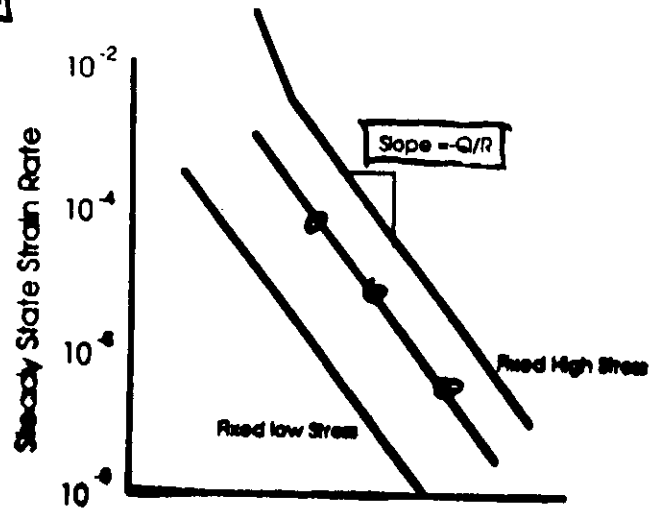
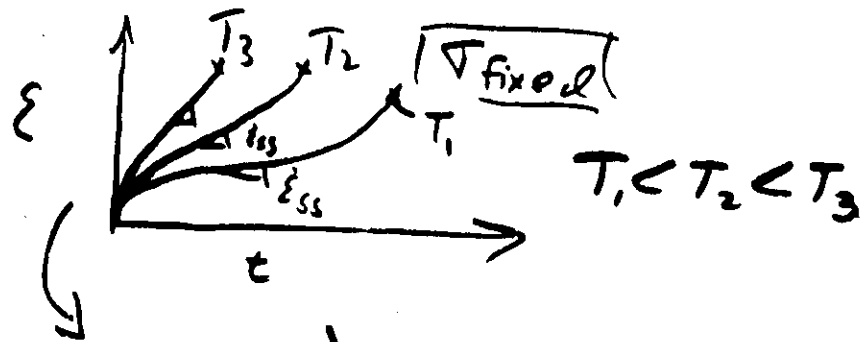
Where

$$\Theta = \exp\left(-\frac{Q_c}{RT}\right)$$

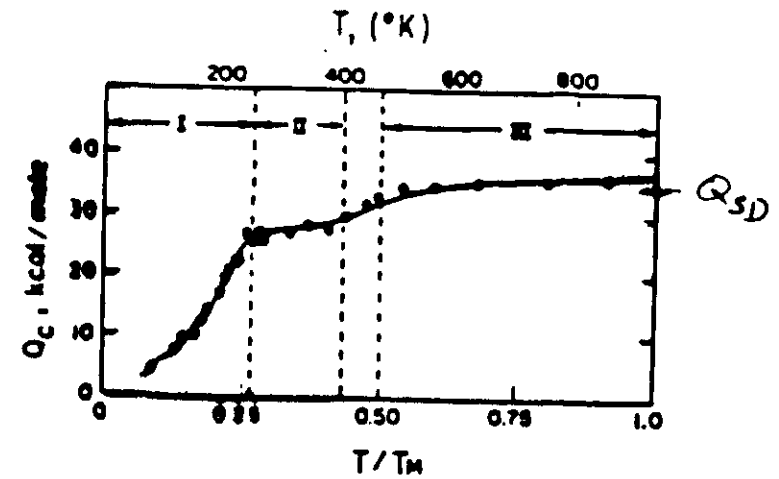


$$Q_c \approx 35,000 \text{ KJ/mol}$$

The usual way to determine Q_c



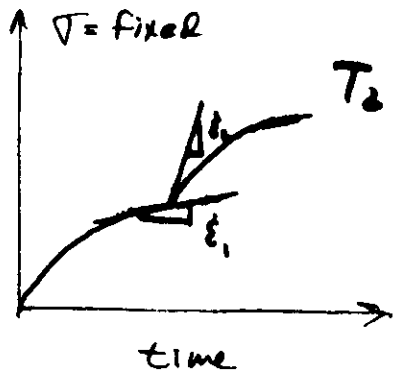
Activation Energy as a f(T) for
Pure Polycrystalline Aluminum



$$Q_{SD} \approx 35 \text{ KJ/mol}$$

from Tracer Experiments

Or can be done by T change expt's



From this we find

1) $Q \neq f(\epsilon)$
(usually)

2) $Q_c = Q_{SD}$

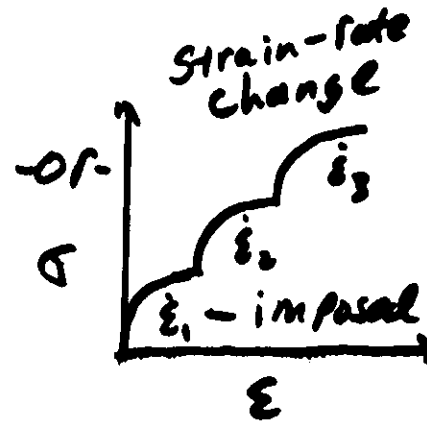
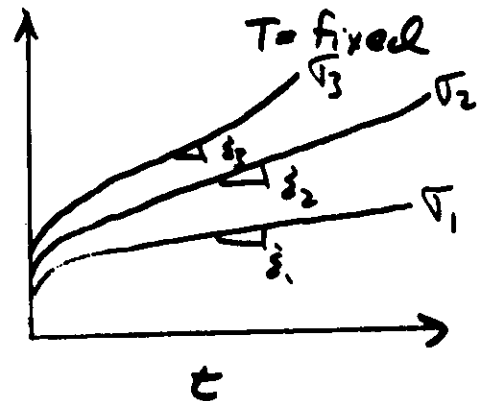
for $T > 0.6 T_m$

The Stress Dependence of Creep

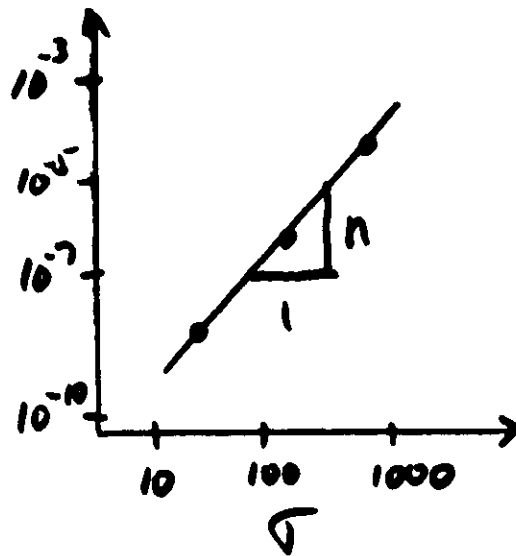
Typical Procedures

Creep

ϵ



$\dot{\epsilon}_{ss}$



$$n = \frac{\partial \ln \dot{\epsilon}}{\partial \ln \sigma}$$

$$m = \frac{1}{n} = \frac{\partial \ln \sigma}{\partial \ln \dot{\epsilon}}$$

n is typically between 1 and 10

* Procedures for finding n & Q can influence measurements

By the results presented, it is suggested that creep (each mechanism) can be described

By

$$\dot{\epsilon} = A \sigma^n \exp\left(-\frac{Q}{RT}\right) \quad (\text{usually})$$

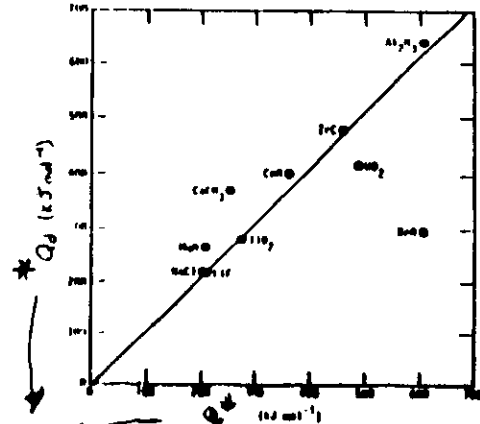
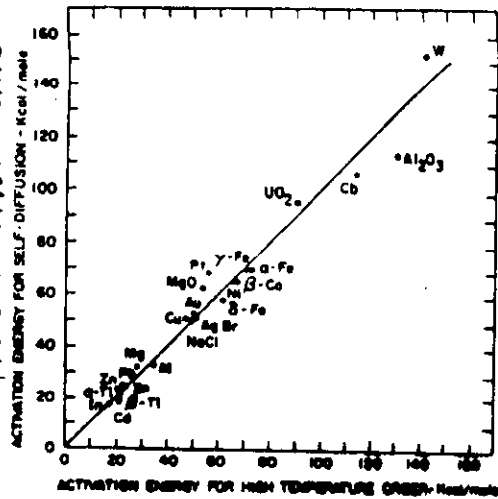
Further:

- n
- Q_c
- Transient Behavior
- Structure (grains, subgrains & dislocations)

can be used to gain fundamental insight to creep deformation.

Evidence For Diffusional Control In Creep

Tracer Experiments



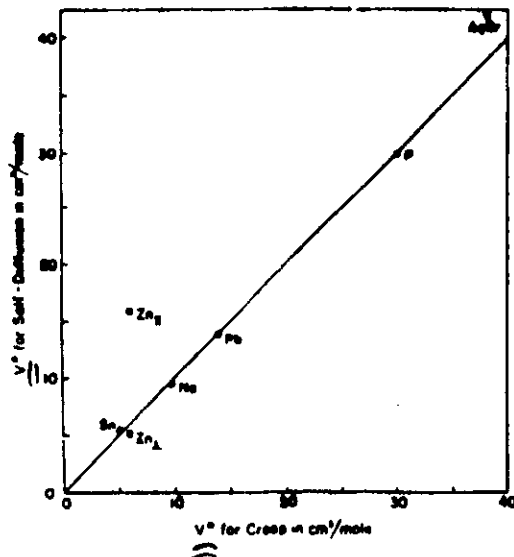
* Slowest species, on fastest path.

Creep Experiments

1) Activation Energy

2) Activation Volume

[Above 0.5 Tm Creep
(Even if by slip) is controlled
by self-diffusion]

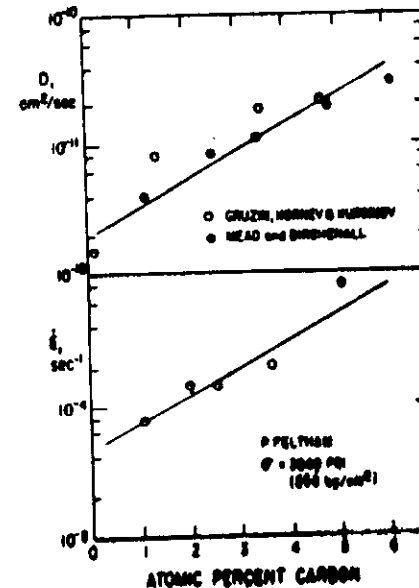


Activation Volumes

$$V_D^* = -RT \frac{\partial \ln D}{\partial P}$$

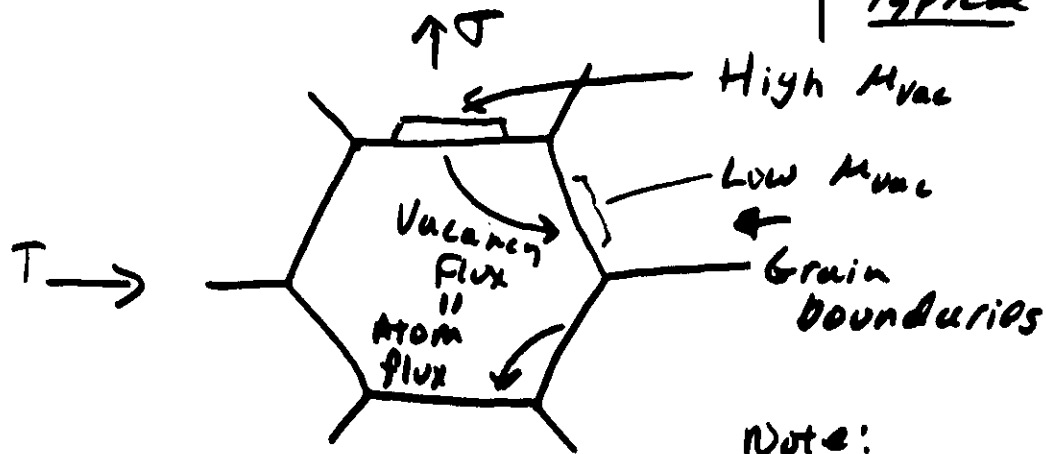
$$V_C^* = -RT \frac{\partial \ln \dot{\epsilon}}{\partial P} \bigg|_T$$

13) Effects of solutes - often have same effect on creep and self-diffusion!

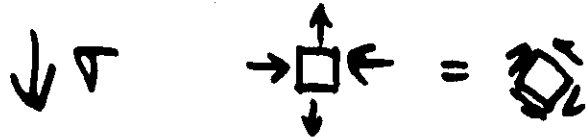


Next let's consider what mechanistic processes can give rise to the behavior illustrated to...

Diffusional Creep | $T > 0.9 T_m$
 (no dislocation motion) | $\dot{\gamma} < 10^{-5}$
 Typical



Note:



Energy barrier to Vacancy Formation

Tensile: $E = (Q_f - \gamma b^3)$ comp: $E = (Q_f + \gamma b^3)$

Vacancy concentration gradient sets up a diffusional flux. Diffusion can be both grain boundaries and through the lattice.

* Analogous problem to sintering, but different driving force. 11-25

If Bulk Diffusion controls:

Nabarro - Herring Creep:

$$\dot{\epsilon} = 0.7 B \frac{D_{gb}}{kT} \left(\frac{b}{G}\right)^2 \sigma$$

$B = \text{Constant (Geometry)}$ 12-40*
 $G = \text{Grain size}$; $b = \text{Burgers vector}$

Note: $n=1$, $Q = Q_L$, G^{-2}

If Grain boundary diffusion Dominates:
 Coble Creep:

$$\dot{\epsilon} = 33.4 \frac{D_{gb} b}{kT} \left(\frac{d_{gb}}{b}\right) \left(\frac{b}{G}\right)^3 \sigma$$

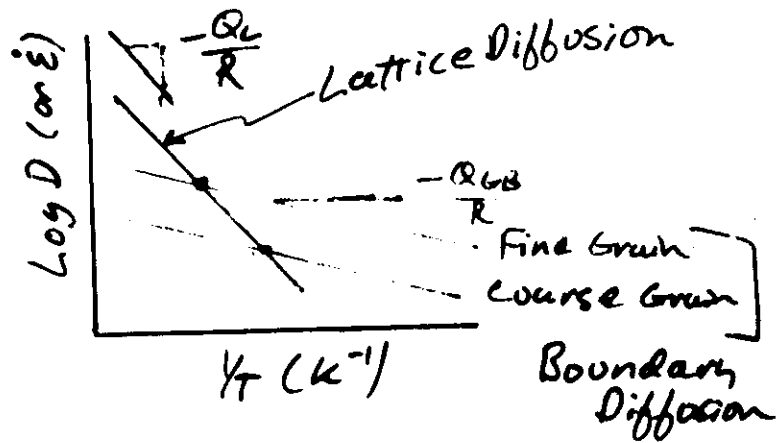
$d_{gb} = \text{boundary thickness}$

$n=1$, $Q = Q_{gb} \approx 0.6 Q_L$, G^{-3}

- Actually Both Are Active!

But one is usually Strongly Favored...

* increasing grain aspect ratio, in the direction of applied stress reduces creep rate (longer diffusion path)



The plot shows Coble (Grain boundary) Creep is favored at:

- + Small grain sizes
- + Lower Temperatures.

- Grains are elongated by diffusional creep
 - Boundary sliding is required to fill space
- Microstructural Evidence "Proves" diffusional creep



Oxide dispersion
Strengthened Alloy

Oxide-free
Zones.

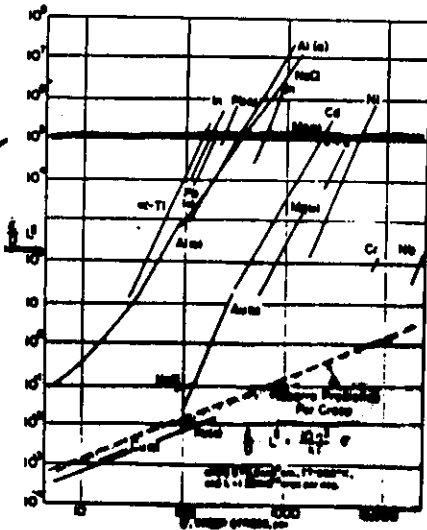
Diffusional flow in Ceramics

- Diffusion of Slowest Species (Usually anion) down the fastest path controls rate.
- If multi-component ceramic (e.g. Y_2O_3 stabilized ZrO_2) we may expect segregation of the faster component to the tops of the grains (not yet observed, however)
- There is a mechanism similar to Diffusional flow (in response), Harper-Dorn creep. Not understood. But,
 - $n=1$
 - $Q_c = Q_L$
 - Based on motion of dislocations
 - $\dot{\epsilon}$ is independent of G .
 - Also occurs @ $T > 0.9 T_m$ and Low stress.

Consider flow @ higher stresses

Slip Creep

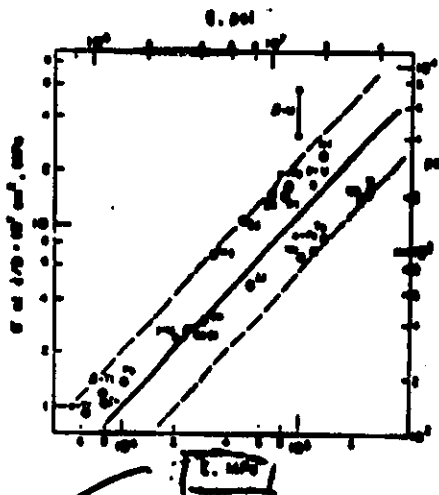
$$\frac{\dot{\epsilon}}{D_L}$$



There is a trend in this range

$n \approx 5$
For Slip creep.

$$\sigma_{flow} = \sqrt[n]{\frac{\dot{\epsilon}}{D_L}} K(M)$$



σ_{flow} of Metal's Properties

Compare Location on Plot above w/ Modulus ...

Dynamic Developed Dislocations

From this we see Creep Resistance has a first-order correlation with Elastic Modulus.

This is expected since the stress field associated with a dislocation varies with E .

We can now estimate slip creep rate as

$$\dot{\epsilon}_{ss} \approx \frac{10^{-11}}{b^2} D_L \left(\frac{\sigma}{E}\right)^5$$

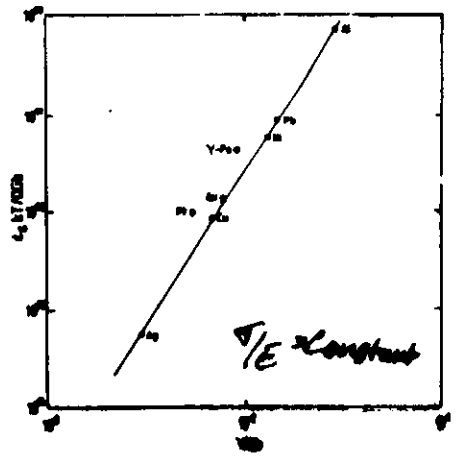
Above $0.6 T_m$ this empirical relation predicts the creep rates of simple metals within a factor of $\sim 10^2 - 10^3$ (or σ at $\dot{\epsilon}_{final}$ within a factor of ~ 3).

Also, to find D_L in the above Eq'n we should hold (σ/E) - not σ - constant, and measure $\dot{\epsilon}$ as $f(T)/\sigma$.

If done at σ fixed anomalously large D_L is found...

$$Q_c^{True} = Q_c^{app} + \frac{nRT^2}{E} \left(\frac{dE}{dT}\right)$$

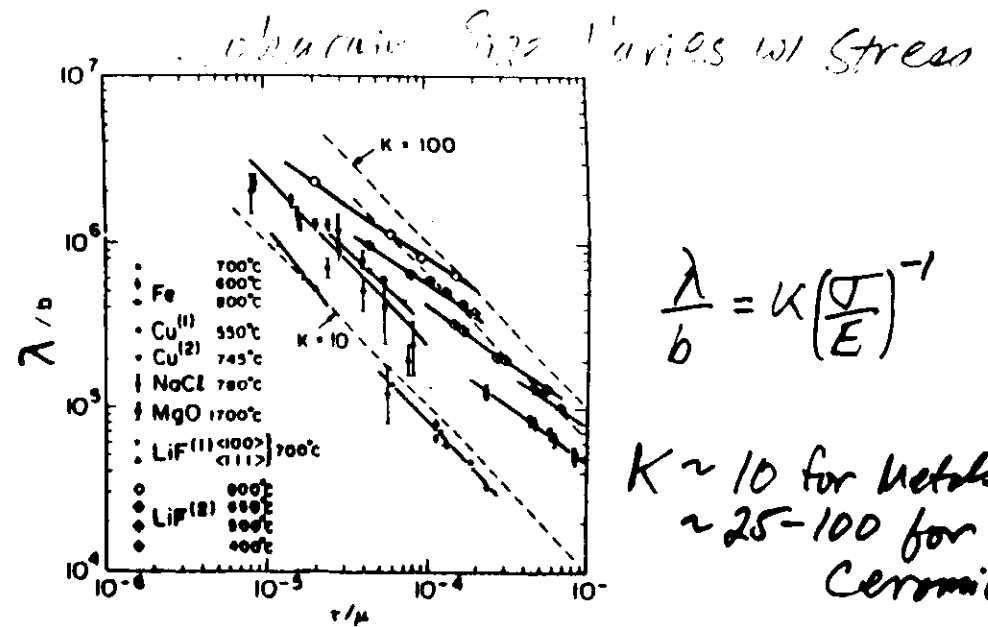
The correlation can be further Enhanced by consideration of Stacking Fault Energy,



Using this information the empirical relation can be refined to:

$$\dot{\epsilon}_{ss} = A D_L \left(\frac{\lambda}{b} \right)^3 \left(\frac{\sigma}{E} \right)^5$$

stopped

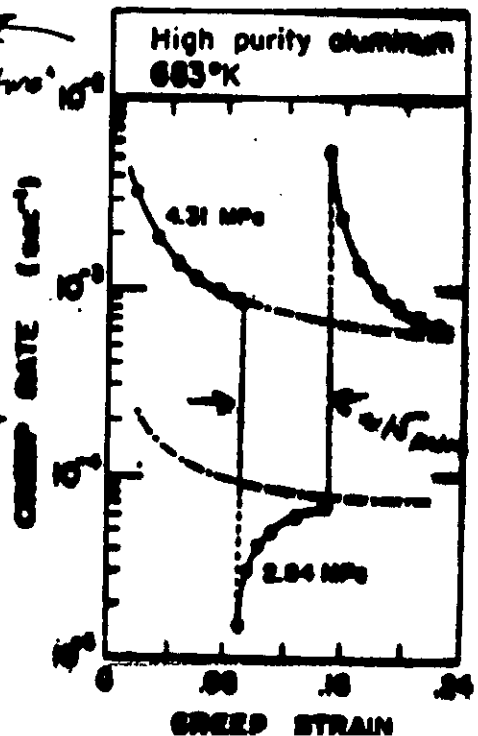
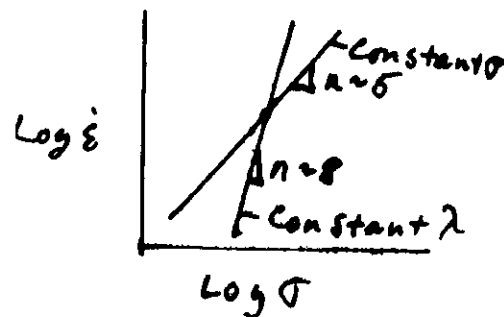


Effect of fixing λ by Sudden σ change

$$\dot{\epsilon} = A \frac{D_{eff}}{b} \left(\frac{\lambda}{b} \right)^3 \left(\frac{\sigma}{E} \right)^8$$

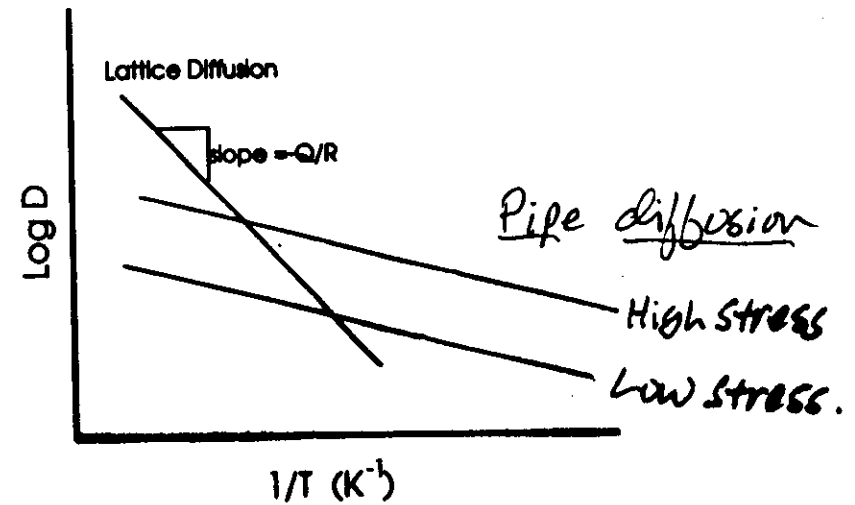
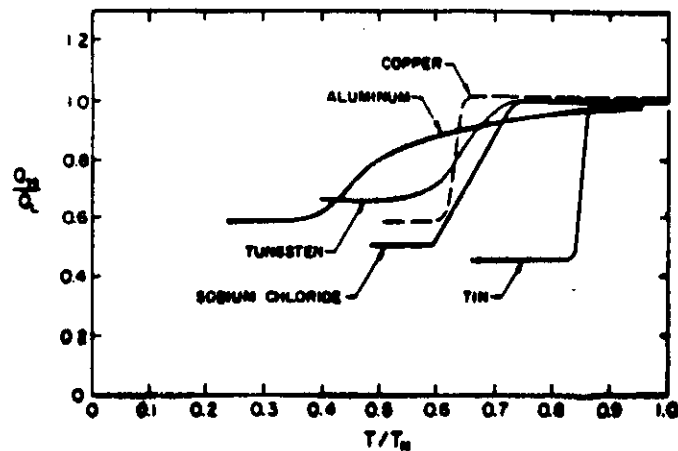
"Constant Structure"

Note: There seems to be a high stress exponent if λ is fixed



Support For Effective Diffusion Concept

Data Taken in Steady State.



We Expect a transition, which is affected by stress.

Low $T \rightarrow$ Pipe diffusion

Then

$$\dot{\epsilon} = A D_p \left(\frac{\sigma}{E} \right)^5$$

$$\text{But } D_p \propto \sigma^2$$

$\therefore$ Effective Stress Exponent

$$= 5 + 2$$

$$= 7$$

$\rightarrow$ This trend is seen.

Another refinement (slightly Contravertical)

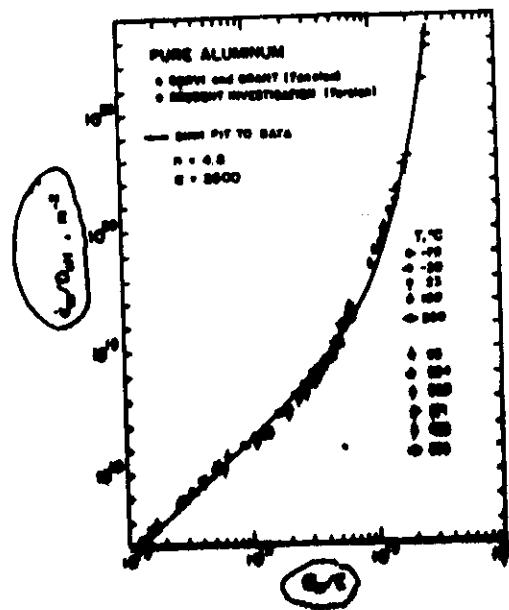
1) Use "Effective" Diffusion coefficient

$$D_{eff} = f_c D_L + A P D_p + B \frac{1}{d} D_{gb}$$

-or-

$$D_{eff} = D_L + 100 \left(\frac{\sigma}{E} \right)^2 D_p$$

2) Use $\dot{\epsilon} = A D_{eff} (\sinh \sigma)^n$
TO Fit high stress behavior



Note: Graph
is not
a $f(T)$!

With these refinements, Luthy, Miller & Sherby were able to correlate Steady State Creep data for Al over 21 orders of Magnitude

